

MINI CROWN EDGE | CROWN EDGE

TE Internal #: 1651826-1

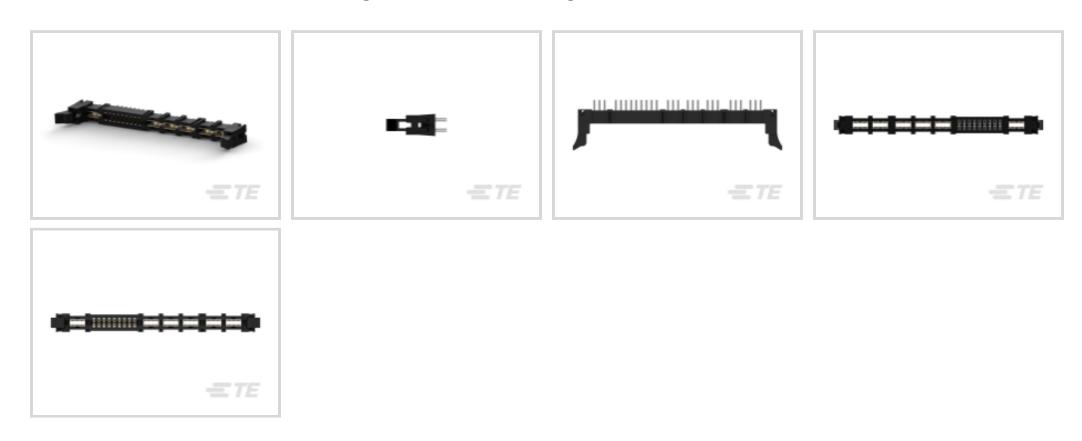
CROWN EDGE, Card Edge Power Connectors, Board-to-Board, 30

Position, 2.5mm [.098in] Centerline, Printed Circuit Board

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Connectors > PCB Connectors > Card Edge Connectors > Card Edge Power Connectors



Connector System: Board-to-Board

Number of Positions: 30

Centerline (Pitch): 2.5 mm [.098 in]

Connector & Contact Terminates To: Printed Circuit Board

Contact Current Rating (Max): 25 A

Features

Product Type Features

| Housing Type | Receptacle |
|-----------------------------------|-----------------------|
| Product Type | Connector Assembly |
| Connector System | Board-to-Board |
| Contact Type | Socket |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| PCB Mount Orientation | Vertical |
|----------------------------|----------|
| Number of Positions | 30 |
| Number of Power Positions | 12 |
| Number of Signal Positions | 18 |
| Number of Dual Positions | 6 |
| Row-to-Row Spacing | 3.33 mm |

Electrical Characteristics

| Operating Voltage | 250 V | |
|-------------------|-------|--|



| Contact Features | |
|--|-----------------------|
| Contact Termination Area Plating Finish | Matte |
| Contact Layout | Staggered |
| Contact Mating Area Plating Material Thickness | .76 μm[29.92 μin] |
| Contact Base Material | Copper Alloy |
| Contact Current Rating (Max) | 25 A |
| Contact Mating Area Plating Material | Gold |
| Contact Termination Area Plating Material | Tin |
| Contact Termination Area Plating Thickness | 120 µin |
| Termination Features | |
| Termination Post & Tail Length | 4.5 mm[.177 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |

| PCB Mount Alignment | With |
|-------------------------|------------------|
| Panel Mount Feature | Without |
| PCB Mount Retention | Without |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| Mating Retention | With |
| Mating Retention Type | Latch |
| Mating Alignment Type | Blindmate, Keyed |

Housing Features

| End Caps | With |
|--------------------|-----------------|
| Centerline (Pitch) | 2.5 mm[.098 in] |
| Housing Color | Black |
| Housing Material | Thermoplastic |

Dimensions

| Card Slot Depth | 6 mm[.236 in] |
|-----------------------------|--------------------------------|
| Accepts Card Width | 93.34 mm[3.67 in] |
| Accepts Card Thickness | 1.57 mm[.062 in] |
| Power Contact Centerline | 9.7 mm[.381 in] |
| PCB Thickness (Recommended) | 1.57 – 3.18 mm[.062 – .125 in] |



| Width | 9.03 mm[.356 in] |
|-----------------------------|----------------------------|
| Length | 114.96 mm[4.53 in] |
| Height | 20 mm[.787 in] |
| Usage Conditions | |
| Operating Temperature Range | -55 – 105 °C[-67 – 221 °F] |
| Operation/Application | |
| Special Features | Custom Configurable |
| Circuit Application | Power & Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Agency/Standard Number | UL 1977 |
| CSA File Number | 1935071 |
| Agency/Standard | CSA, UL |
| Packaging Features | |
| Packaging Method | Box & Tray, Tray |
| Packaging Quantity | 32 |
| Other | |

Product Compliance

For Use With

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Wave solder capable to 265°C |
| | |

Mates with Plug

Product Compliance Disclaimer

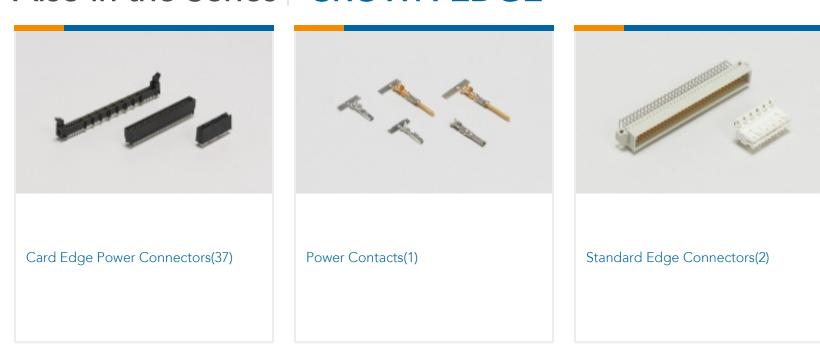


This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | CROWN EDGE



Customers Also Bought

















Documents

Product Drawings 283-0172-01303=CONN,SKT,CRNEDG

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1651826-1_C.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1651826-1_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1651826-1_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

POWER_CONNECTORS_CATALOG_SEC04_VRM

English

Product Specifications

Application Specification

English

Product Environmental Compliance

MD_1651826-1_12052016246_dmtec

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English

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English